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Designed for: Public Release		Mod. Date: 7/24/2013	
Project Title: PSR Flyback with 23-56Vin and 5V/0.6A output		Sheet Title: PSR Flyback with 23-56Vin and 5V/0.6A output	
Number: PMP9009	Rev: A	Assembly Variant: 001	Sheet: 1 of 2
SVN Rev: Not in version control	Drawn By: S Yu	File: PMP9009_02.SchDoc	Size: B
Engineer: S Yu	Contact: http://www.ti.com/support	http://www.ti.com	
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PCB Number: PMP9009
PCB Rev: A

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Number: PMP9009		Rev: A	Designed for: Public Release		Mod. Date: 6/19/2013
SVN Rev: Not in version control		Assembly Variant: 001		Project Title: PSR Flyback with 23-56Vin and 5V/0.6A output	
Drawn By:		File: PMP9009_03.SchDoc		Sheet: 2 of 2	
Engineer: S Yu		Contact: http://www.ti.com/support		Size: B	



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